



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: YOSHIDA, AKITO DOCKET NO.: W2K1077
SERIAL NO: 10/082,472 EXAMINER: ZARNEKE
FILED: 02/22/2002 ART UNIT: 2827
TITLE: A STACKING STRUCTURE FOR SEMICONDUCTOR DEVICES
USING A FOLDED OVER FLEXIBLE SUBSTRATE AND METHOD
THEREFOR

Mail Stop: Non-Fee Amendment
Commissioner for Patents Weiss, Moy & Harris, P.C.
P.O. Box 1450 4204 N. Brown Avenue
Alexandria, VA 22313-1450 Scottsdale, AZ 85251-3989

February 4, 2004

I hereby certify that on the 4th day of February, 2004,
this correspondence is being deposited with the U.S.
Postal Service as first class mail in an envelope
addressed to: Commissioner for Patents, P.O. Box 1450
Alexandria, VA 22313-1450.



Jeffrey D. Moy

DRAFT AMENDMENT

Dear Sir:

This is in response to the Office Action dated October 10, 2003 in regards to the above identified patent application. Please amend the subject patent application as follows: